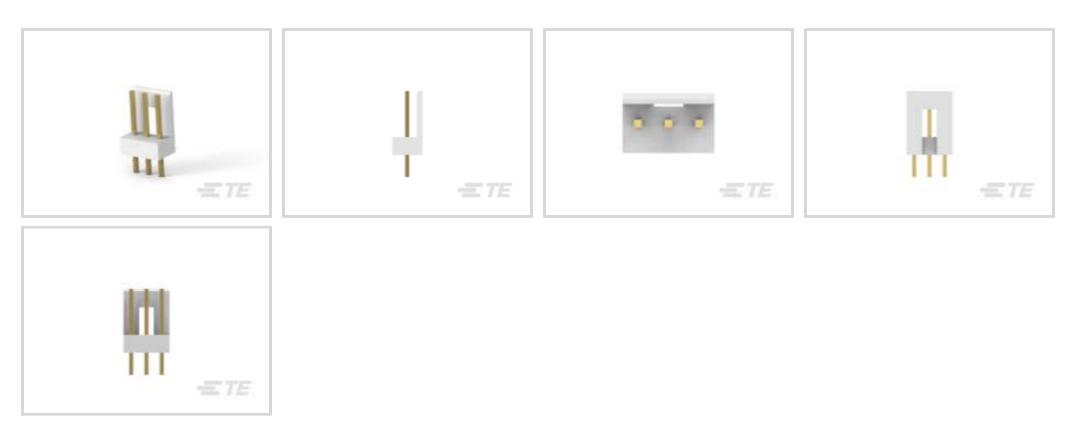
173081-3 - ACTIVE

TE Internal #: 173081-3 PCB Mount Header, Vertical, Wire-to-Board, 3 Position, 2.5 mm [. 098 in] Centerline, Partially Shrouded, Gold, Through Hole - Solder, Signal, Natural

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



Connector System: Wire-to-Board

Number of Positions: 3

Number of Rows: 1

Centerline (Pitch): 2.5 mm [.098 in]

PCB Mount Orientation: Vertical

Features

Product Type Features



Header Type Part	rtially Shrouded
Sealable No	C
Connector & Contact Terminates To Prin	inted Circuit Board
PCB Connector Assembly Type PCB	CB Mount Header
Configuration Features	
Number of Positions 3	
Number of Rows 1	
PCB Mount Orientation Ver	ertical
Electrical Characteristics	
Operating Voltage 250	0 VAC
Body Features	
Primary Product Color Nat	atural
Contact Features	

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PCB Mount Header, Vertical, Wire-to-Board, 3 Position, 2.5 mm [.098 in] Centerline, Partially Shrouded, Gold, Through Hole - Solder, Signal, Natural



Contact Mating Area Length	7.5 mm[.295 in]
Mating Square Post Dimension	.64 mm[.025 in]
Contact Shape & Form	Square
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Brass
Contact Mating Area Plating Material	Gold
Contact Type	Pin
Contact Current Rating (Max)	3.5 A
Termination Features	
Termination Post & Tail Length	3.6 mm[.142 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Retention	With
PCB Mount Retention Type	Retention Solder Tails
Mating Retention Type	Polarized Lock
Connector Mounting Type	Board Mount
Mating Alignment	Without
PCB Mount Alignment	Without
PCB Mount Retention	Without
Housing Features	
Housing Material	66 Nylon
Centerline (Pitch)	2.5 mm[.098 in]
Dimensions	
Connector Length	7.5 mm[.295 in]
Connector Height	10.4 mm[.409 in]
Usage Conditions	
Operating Temperature Range	-20 – 95 °C[-4 – 203 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
Agency/Standard	UL
UL Flammability Rating	UL 94V-0

PCB Mount Header, Vertical, Wire-to-Board, 3 Position, 2.5 mm [.098 in] Centerline, Partially Shrouded, Gold, Through Hole - Solder, Signal, Natural



Packaging Features

Packaging Quantity	1000
Packaging Type	Bag

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2023 (233) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

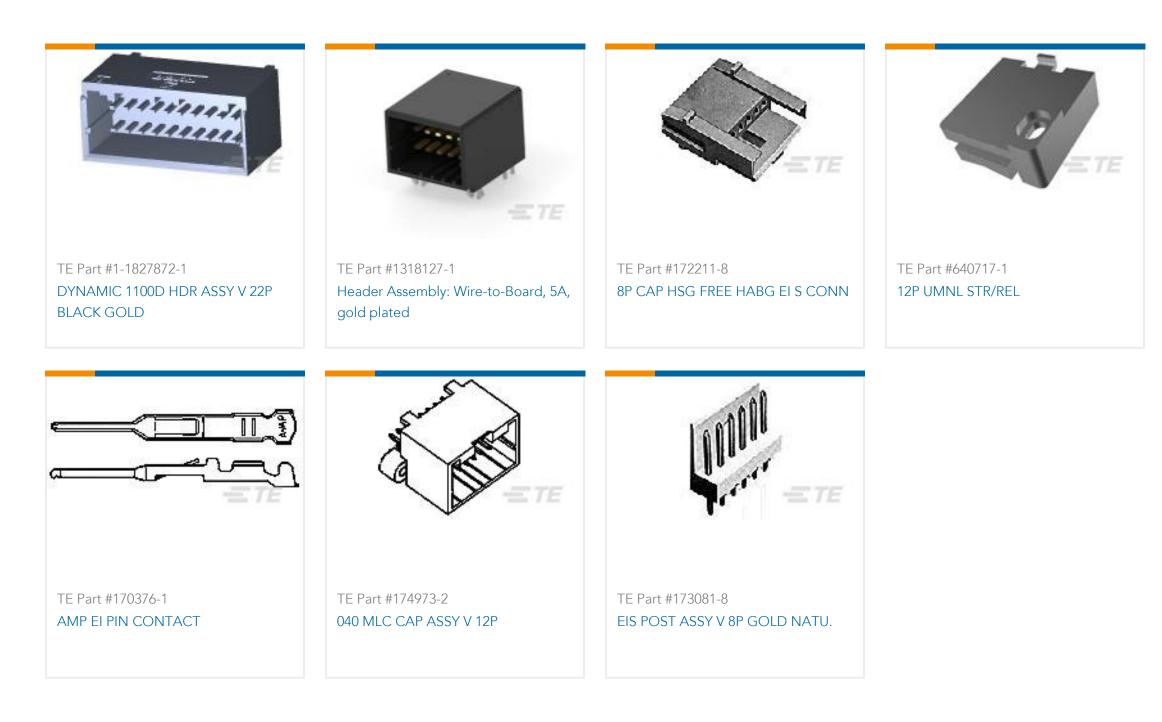
Compatible Parts



Customers Also Bought

PCB Mount Header, Vertical, Wire-to-Board, 3 Position, 2.5 mm [.098 in] Centerline, Partially Shrouded, Gold, Through Hole - Solder, Signal, Natural





Documents

Product Drawings EIS POST ASSY V 3P GOLD NATU.

English

CAD Files 3D PDF

3D

Customer View Model ENG_CVM_CVM_173081-3_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_173081-3_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_173081-3_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages 1-1773972-5_EIS_Connectors_Brochure

English

Product Specifications Crimping of AMP El Series Connector Contacts

Japanese

Application Specification

Japanese

PCB Mount Header, Vertical, Wire-to-Board, 3 Position, 2.5 mm [.098 in] Centerline, Partially Shrouded, Gold, Through Hole - Solder, Signal, Natural



Product Environmental Compliance

Product Compliance

English

Product Compliance

English

Agency Approvals Agency Approval Document

English